

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S1 series

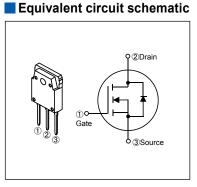
N-Channel enhancement mode power MOSFET

Features

Pb-free lead terminal **RoHS** compliant

Applications For switching

Outline Drawings [mm] TO-3P + + +



Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		+22	A	Tc=25°C Note*1
	10 A Ray	的公司任自己	А	Tc=100°C Note*1
Pulsed Drain Current	IDP/	\$158 #66 4 P	A	Note *1
Gate-Source Voltage	VGs C D	5 × (±30)	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	MAR 2	diffet	А	Note *2
Non-Repetitive Maximum Avalanche Energy	FACE IPI	548.9 548.9	す∘ mJ	Note *3
Maximum Drain-Source dV/dt	dVos/dt	5願し、50	kV/ns	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt/J	igning 5	kV/ns	Note *4
Peak Diode Recovery - di/dt	-di/dt new des	100	A/µs	Note *5
Maximum Power Dissipation 注:新規設計にはない Operating and Storage Temperature Pange	in tor	2.5	w	T _a =25°C
		170	vv	Tc=25°C
Operating and Storage Temperature Operating	Tch	150	°C	
Operating and Storage remperature range	Tstg	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, IAs=4A, L=62.9mH, VpD=60V, RG=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-ID, -di/dt=100A/µs, VDs peak≤ 600V, Tch≤150°C.

Note *5 : I⊧≤-I_D, dV/dt=15kV/µs, V_{DS peak}≤ 600V, T_{ch}≤150°C.

Electrical Characteristics at Tc=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I₀=250μA V₅s=0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=250µA V₀s=V₀s		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current		V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	
	IDSS	V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	μA
Gate-Source Leakage Current	Igss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I₀=11A V₀s=10V		-	0.136	0.16	Ω
Gate resistance	RG	f=1MHz, open drain		-	3.5	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =11A V _{DS} =25V	10.5	21	-	S
Input Capacitance	Ciss	V _{DS} =10V	15/2	1710	-	
Output Capacitance	Coss	V _{GS} =0V	STAT	3660	-	
Reverse Transfer Capacitance	Crss	f=1MHz	\$75A	350	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{cs} =0V V _{cs} =0480V		100	-	pF
Effective output capacitance, time related (Note *7)	- Cont	Ves=0V Vos=0480V Io=constant	duct	350 ≢∮∘	-	
Turn-On Time	td(on)	- tomalille - the	NN120	52 🗸	-	
Turn-On Time	to Man	100=400V, VGS=10V	ind.	18.5	-	
Turn-Off Time	talot	See Fig 3 and Fig 4 and design	- כיוו	146	-	ns
Turn-On Time	t,	Eticit en for new	-	17.5	-	
Total Gate Charge	- Qo新規同	Vo= 400V, Vos=10V Vo= 400V, Vos=10V Vo= 400V, Vos=10V See Fig.3 and Fig.4 FIC Volume for new design Vos=480V, Ib=22A Vos=10V See Fig.5	-	57	-	
Gate-Source Charge	Pase DO	\Vbd=480V, l₀=22A	-	14	-	20
Gate-Drain Charge	QGD		-	19.5	-	nC
Drain-Source crossover Charge	Qsw		-	8.5	-	

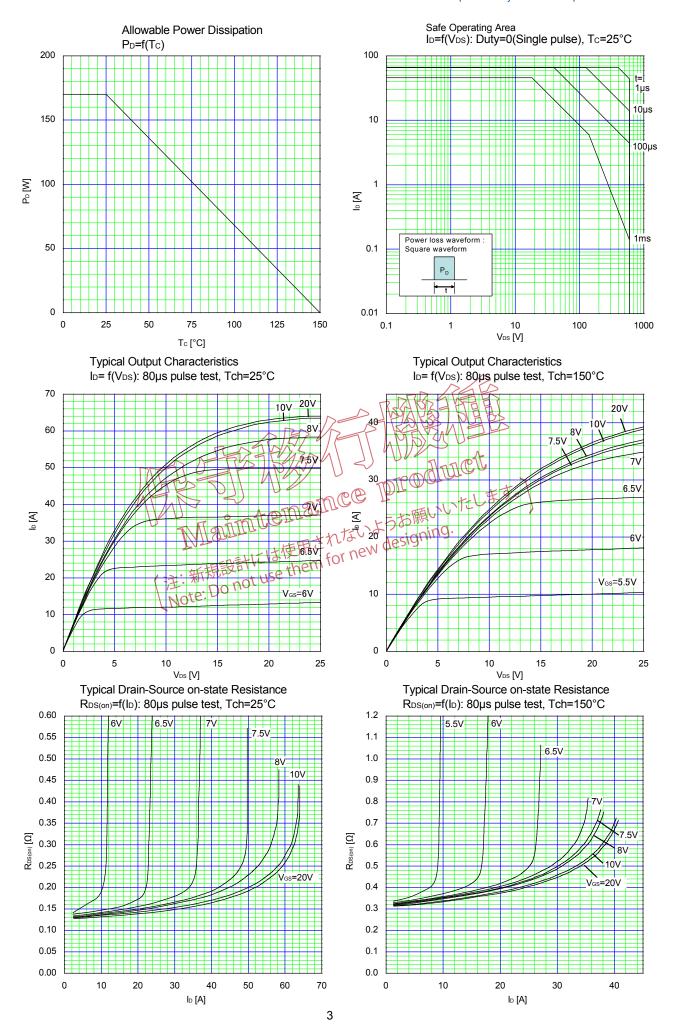
Note *6 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% BV_{DSS}. Note *7 : $C_{0(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 80% BV_{DSS}.

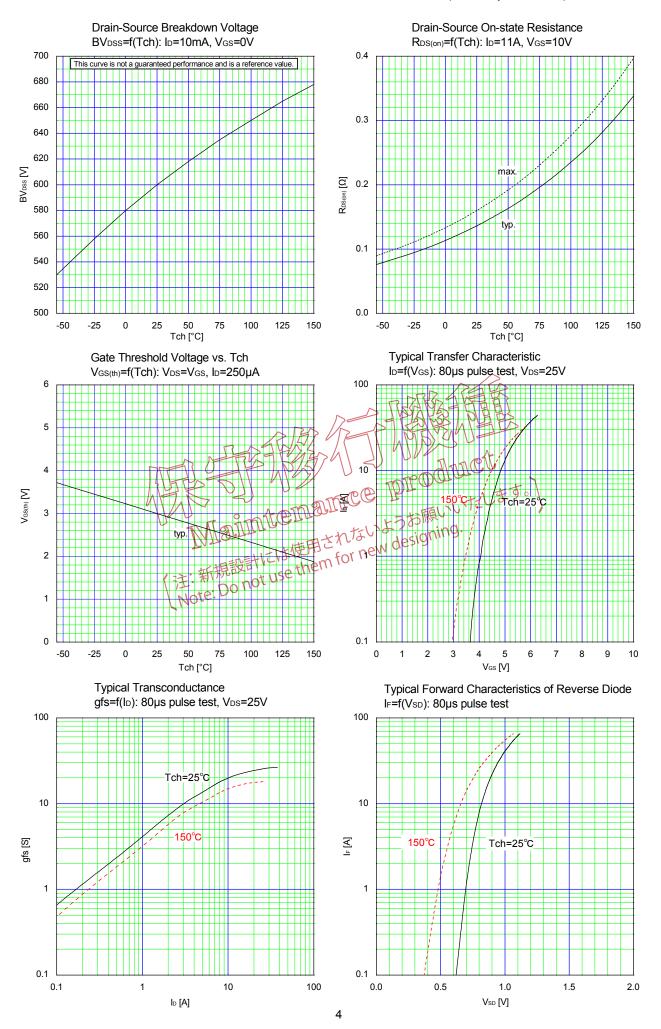
Reverse Diode

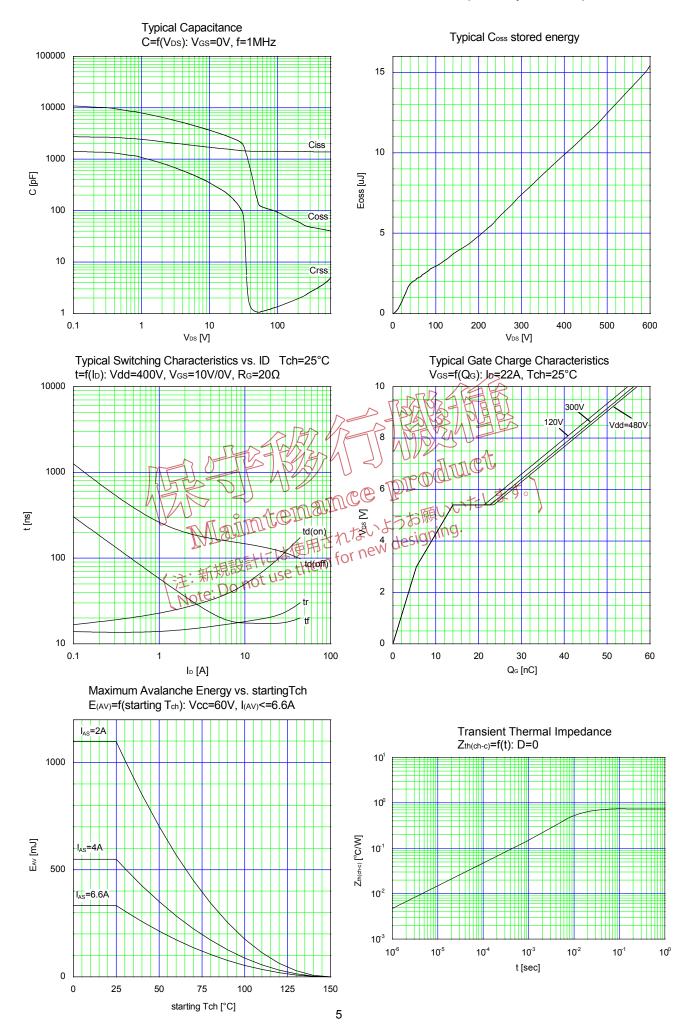
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=14mH, T₀+=25°C See Fig.1 and Fig.2	6.6	-	-	V
Diode Forward On-Voltage	V _{SD}	I⊧=22A, V₀s=0V T₀h=25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	- I⊧=22A, V₀₀=400V -di/dt=100A/μs T₅h=25°C See Fig.6 and Fig.7	-	380	-	ns
Reverse Recovery Charge	Qrr		-	6.5	-	μC
Peak Reverse Recovery Current	Irp		-	34	-	А

Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.74	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W







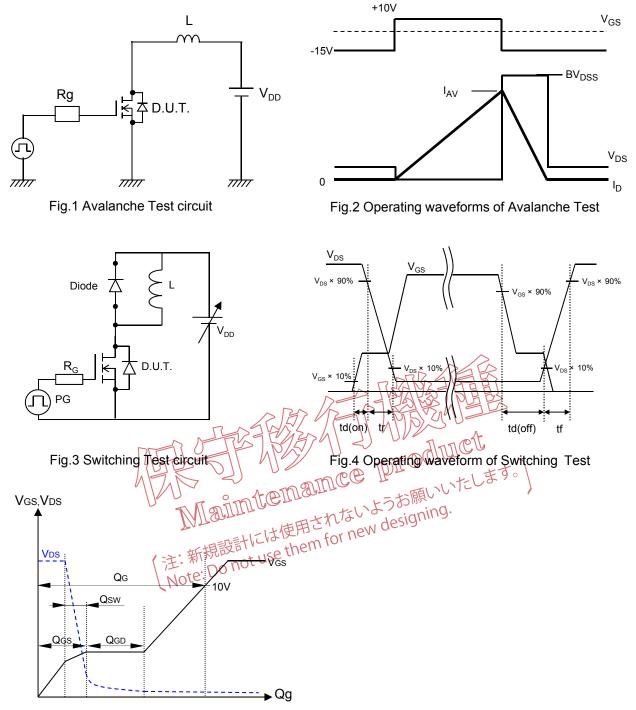
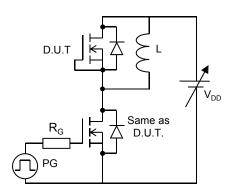


Fig.5 Operating waveform of Gate charge Test



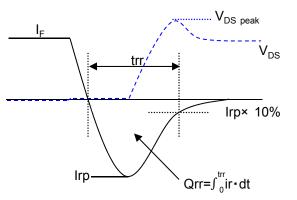
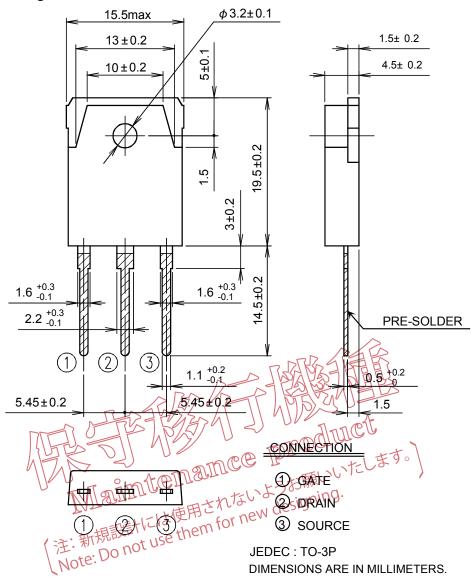


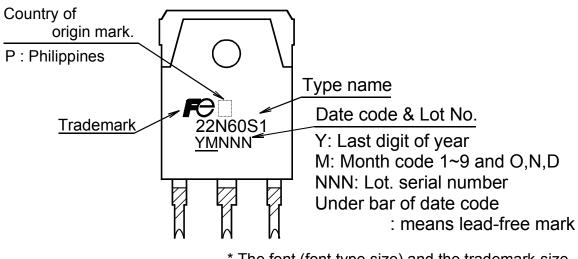
Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-3P Package



Marking



* The font (font type,size) and the trademark-size might be actually different.

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